

Surface Mount Trench MOS Barrier Schottky Rectifier



FEATURES

- Very low profile - typical height of 0.95 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
- Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
 COMPLIANT
 HALOGEN
FREE

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	3 A
V_{RRM}	60 V
I_{FSM}	80 A
V_F at $I_F = 3$ A (125 °C)	0.46 V
T_J max.	175 °C
Package	DO-221AC (SlimSMA)
Diode variation	Single die

TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: DO-221AC (SlimSMA)

Molding compound meets UL 94 V-0 flammability rating
 Base P/N-M3 - halogen-free, RoHS-compliant
 Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)			
PARAMETER	SYMBOL	VSSAF3M6	UNIT
Device marking code		3M6	
Maximum repetitive peak reverse voltage	V_{RRM}	60	V
Maximum DC forward current	$I_{F(AV)}$ ⁽¹⁾	2.5	A
	$I_{F(AV)}$ ⁽²⁾	3	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	80	A
Operating junction and storage temperature range	T_J, T_{STG}	-40 to +175	°C

Notes

- (1) Free air, mounted on recommended copper pad area
- (2) Mounted on 30 mm x 30 mm pad area



ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 1.5 A	T _A = 25 °C	V _F ⁽¹⁾	0.49	-	V
	I _F = 3 A			0.54	0.62	
	I _F = 1.5 A	T _A = 125 °C		0.39	-	
	I _F = 3 A			0.46	0.54	
Reverse current	V _R = 60 V	T _A = 25 °C	I _R ⁽²⁾	-	0.3	mA
		T _A = 125 °C		2.0	6.0	
Typical junction capacitance	4.0 V, 1 MHz		C _J	500	-	pF

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
- (2) Pulse test: pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise specified)			
PARAMETER	SYMBOL	VSSAF3M6	UNIT
Typical thermal resistance	R _{θJA} ⁽¹⁾⁽²⁾	115	°C/W
	R _{θJM} ⁽³⁾	12	

Notes

- (1) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance R_{θJA} - junction to ambient, R_{θJM} - junction to mount
- (2) The heat generated must be less than thermal conductivity from junction-to-ambient: dP_D/DT_J < 1/R_{θJA}
- (3) Mounted on 30 mm x 30 mm pad area

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
VSSAF3M6-M3/H	0.032	H	3500	7" diameter plastic tape and reel
VSSAF3M6-M3/I	0.032	I	14 000	13" diameter plastic tape and reel
VSSAF3M6HM3/H ⁽¹⁾	0.032	H	3500	7" diameter plastic tape and reel
VSSAF3M6HM3/I ⁽¹⁾	0.032	I	14 000	13" diameter plastic tape and reel

Note

- (1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

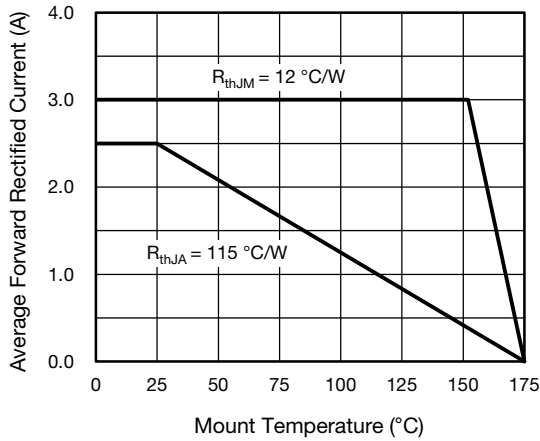


Fig. 1 - Maximum Forward Current Derating Curve

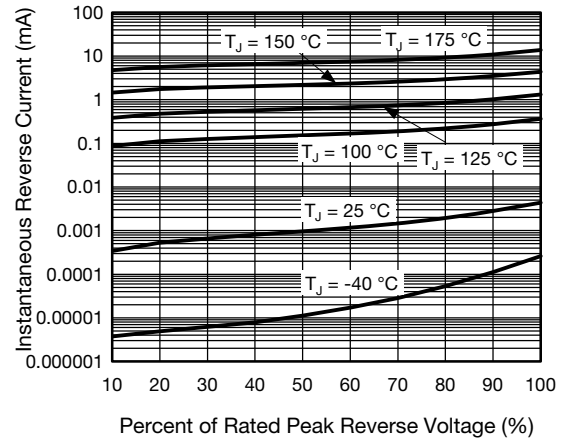


Fig. 4 - Typical Reverse Leakage Characteristics

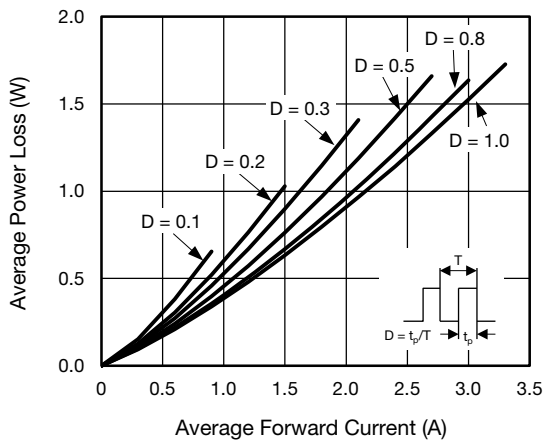


Fig. 2 - Forward Power Loss Characteristics

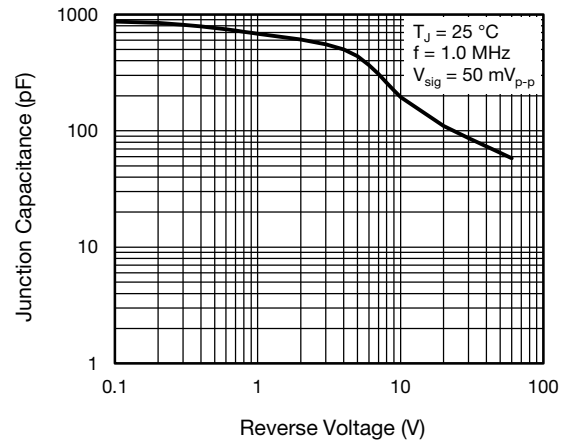


Fig. 5 - Typical Junction Capacitance

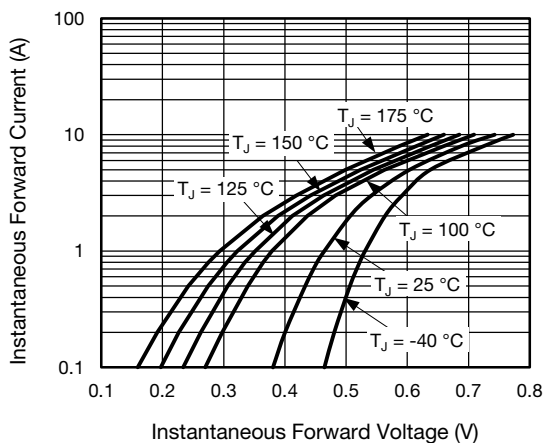


Fig. 3 - Typical Instantaneous Forward Characteristics

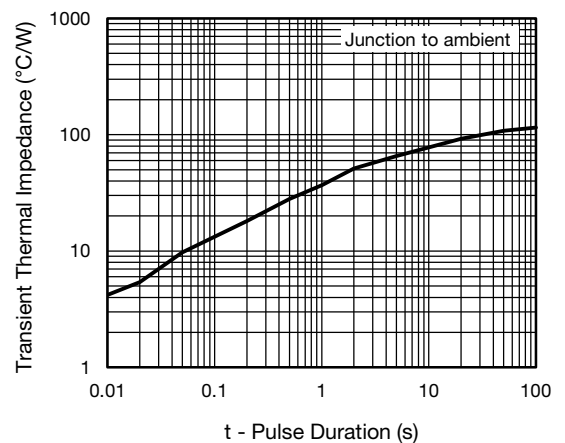


Fig. 6 - Typical Transient Thermal Impedance

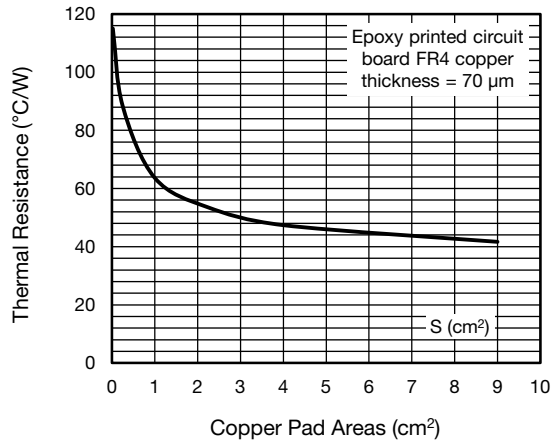
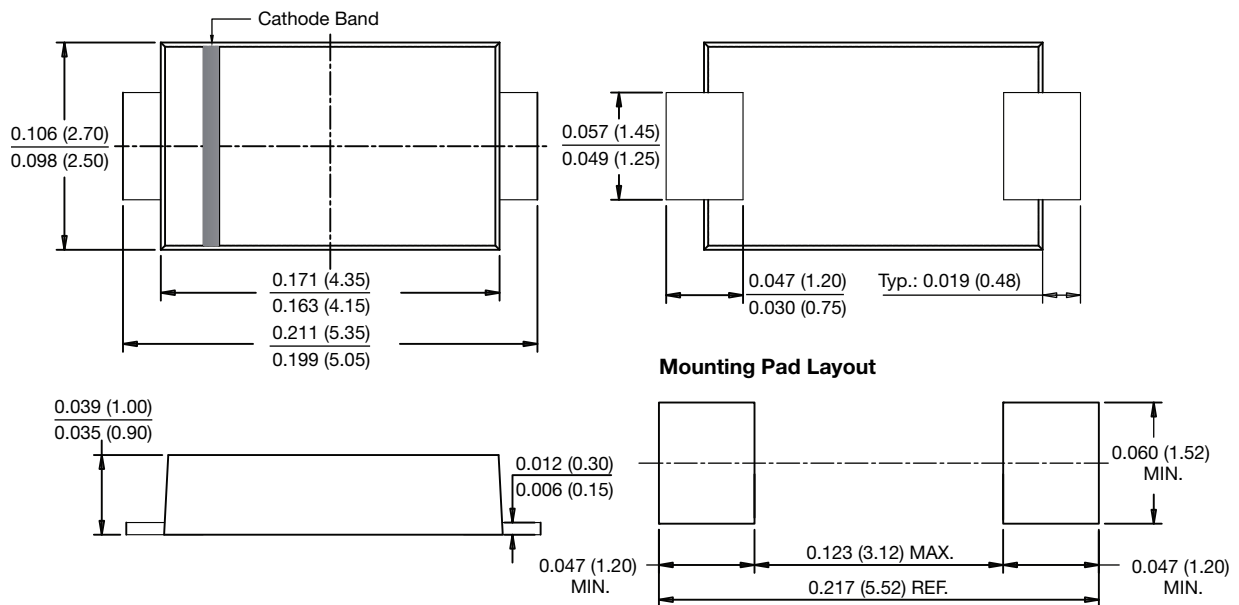


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Area

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-221AC (SlimSMA)





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